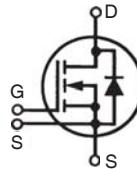


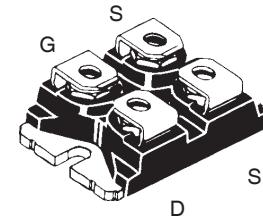
**X2-Class HiPerFET™
Power MOSFET**
IXFN100N65X2

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode



V_{DSS} = 650V
I_{D25} = 78A
R_{DS(on)} ≤ 30mΩ

miniBLOC, SOT-227
 E153432



G = Gate D = Drain
S = Source

| Symbol | Test Conditions | Maximum Ratings | | |
|-------------------|--|-----------------|----------|------|
| V _{DSS} | T _J = 25°C to 150°C | 650 | | V |
| V _{DGR} | T _J = 25°C to 150°C, R _{GS} = 1MΩ | 650 | | V |
| V _{GSS} | Continuous | ± 30 | | V |
| V _{GSM} | Transient | ± 40 | | V |
| I _{D25} | T _C = 25°C | 78 | | A |
| I _{DM} | T _C = 25°C, Pulse Width Limited by T _{JM} | 200 | | A |
| I _A | T _C = 25°C | 15 | | A |
| E _{AS} | T _C = 25°C | 3.5 | | J |
| P _D | T _C = 25°C | 595 | | W |
| dv/dt | I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C | 50 | | V/ns |
| T _J | | -55 ... +150 | | °C |
| T _{JM} | | 150 | | °C |
| T _{stg} | | -55 ... +150 | | °C |
| V _{ISOL} | 50/60 Hz, RMS | t = 1 minute | 2500 | V~ |
| | I _{ISOL} ≤ 1mA | t = 1 second | 3000 | V~ |
| M _d | Mounting Torque | 1.5/13 | Nm/lb.in | |
| | Terminal Connection Torque | 1.3/11.5 | Nm/lb.in | |
| Weight | | 30 | | g |

| Symbol | Test Conditions (T _J = 25°C Unless Otherwise Specified) | Characteristic Values | | |
|---------------------|---|-----------------------|-------|------|
| | | Min. | Typ. | Max. |
| BV _{DSS} | V _{GS} = 0V, I _D = 1mA | 650 | | V |
| V _{GS(th)} | V _{DS} = V _{GS} , I _D = 4mA | 3.5 | | V |
| I _{GSS} | V _{GS} = ± 30V, V _{DS} = 0V | | ± 100 | nA |
| I _{DSS} | V _{DS} = V _{DSS} , V _{GS} = 0V | | 50 | μA |
| | T _J = 125°C | | 5 | mA |
| R _{DS(on)} | V _{GS} = 10V, I _D = 50A, Note 1 | | 30 | mΩ |

Features

- International Standard Package
- miniBLOC, with Aluminium Nitride Isolation
- Isolation Voltage 2500V~
- High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Low R_{DS(on)}

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls

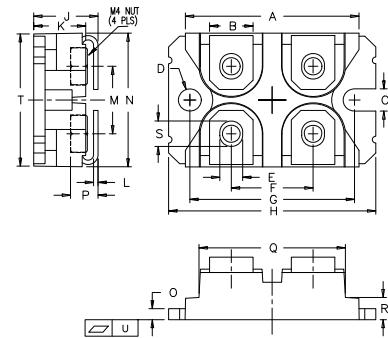
| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|-------------------------------------|---|-----------------------|------|---------------------------|
| | | Min. | Typ. | Max |
| g_{fs} | $V_{DS} = 10\text{V}$, $I_D = 50\text{A}$, Note 1 | 40 | 68 | S |
| R_{Gi} | Gate Input Resistance | | 0.7 | Ω |
| C_{iss} | $V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$ | | 10.8 | nF |
| C_{oss} | | | 6000 | pF |
| C_{rss} | | | 2.6 | pF |
| Effective Output Capacitance | | | | |
| $C_{o(er)}$ | Energy related } $V_{GS} = 0\text{V}$ | | 365 | pF |
| $C_{o(tr)}$ | Time related } $V_{DS} = 0.8 \cdot V_{DSS}$ | | 1500 | pF |
| $t_{d(on)}$ | $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 50\text{A}$ $R_G = 2\Omega$ (External) | | 37 | ns |
| t_r | | | 26 | ns |
| $t_{d(off)}$ | | | 90 | ns |
| t_f | | | 13 | ns |
| $Q_{g(on)}$ | $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 50\text{A}$ | | 183 | nC |
| Q_{gs} | | | 60 | nC |
| Q_{gd} | | | 62 | nC |
| R_{thJC} | | | 0.21 | $^\circ\text{C}/\text{W}$ |
| R_{thCS} | | 0.05 | | $^\circ\text{C}/\text{W}$ |

Source-Drain Diode

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|----------|---|-----------------------|------|---------------|
| | | Min. | Typ. | Max. |
| I_s | $V_{GS} = 0\text{V}$ | | 100 | A |
| I_{SM} | Repetitive, Pulse Width Limited by T_{JM} | | 400 | A |
| V_{SD} | $I_F = I_S$, $V_{GS} = 0\text{V}$, Note 1 | | 1.4 | V |
| t_{rr} | $I_F = 50\text{A}$, $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 100\text{V}$, $V_{GS} = 0\text{V}$ | | 200 | ns |
| Q_{RM} | | | 1.7 | μC |
| I_{RM} | | | 17.2 | A |

Note 1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

SOT-227B (IXFN) Outline



(M4 screws (4x) supplied)

| SYM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.240 | 1.255 | 31.50 | 31.88 |
| B | .307 | .323 | 7.80 | 8.20 |
| C | .161 | .169 | 4.09 | 4.29 |
| D | .161 | .169 | 4.09 | 4.29 |
| E | .161 | .169 | 4.09 | 4.29 |
| F | .587 | .595 | 14.91 | 15.11 |
| G | 1.186 | 1.193 | 30.12 | 30.30 |
| H | 1.496 | 1.505 | 38.00 | 38.23 |
| J | .460 | .481 | 11.68 | 12.22 |
| K | .351 | .378 | 8.92 | 9.60 |
| L | .030 | .033 | .76 | .84 |
| M | .496 | .506 | 12.60 | 12.85 |
| N | .990 | 1.001 | 25.15 | 25.42 |
| O | .078 | .084 | 1.98 | 2.13 |
| P | .195 | .235 | 4.95 | 5.97 |
| Q | 1.045 | 1.059 | 26.54 | 26.90 |
| R | .155 | .174 | 3.94 | 4.42 |
| S | .186 | .191 | 4.72 | 4.85 |
| T | .968 | .987 | 24.59 | 25.07 |
| U | -.002 | .004 | -0.05 | 0.1 |

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

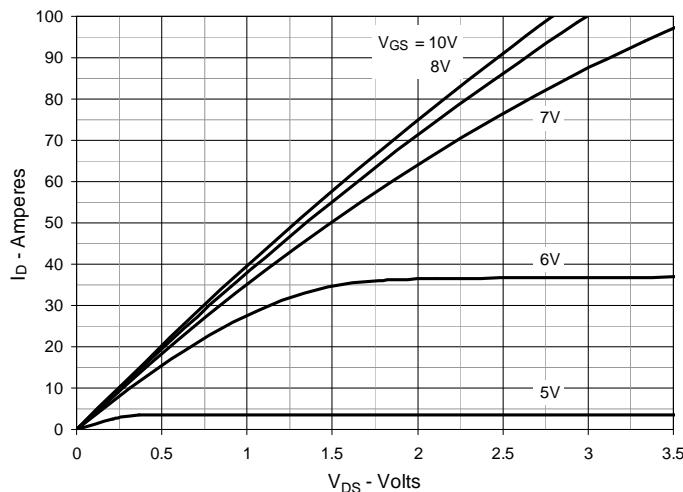
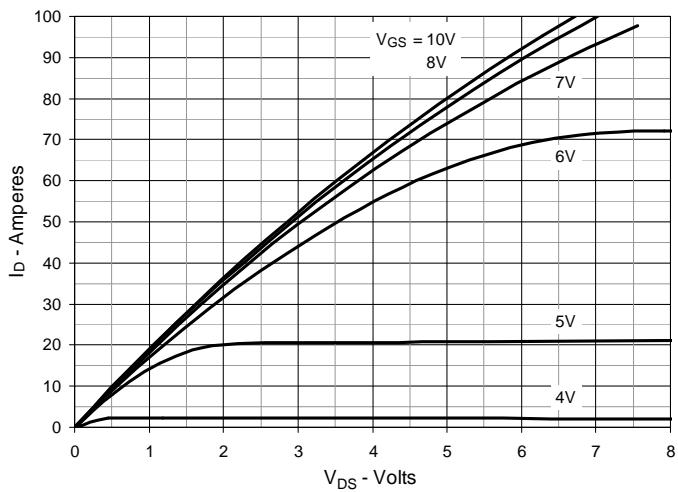
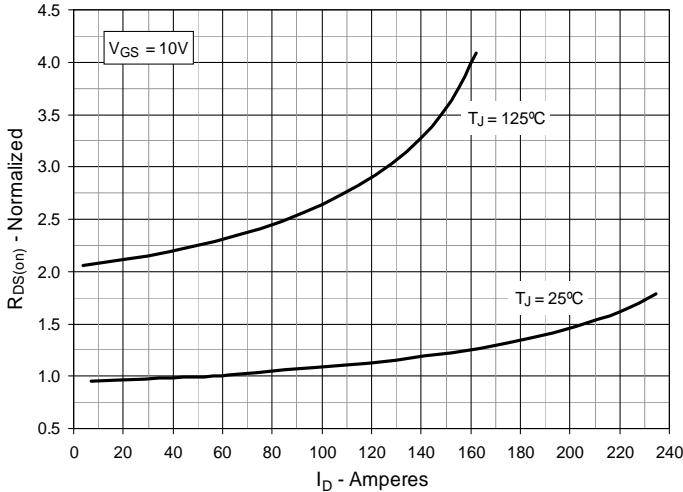
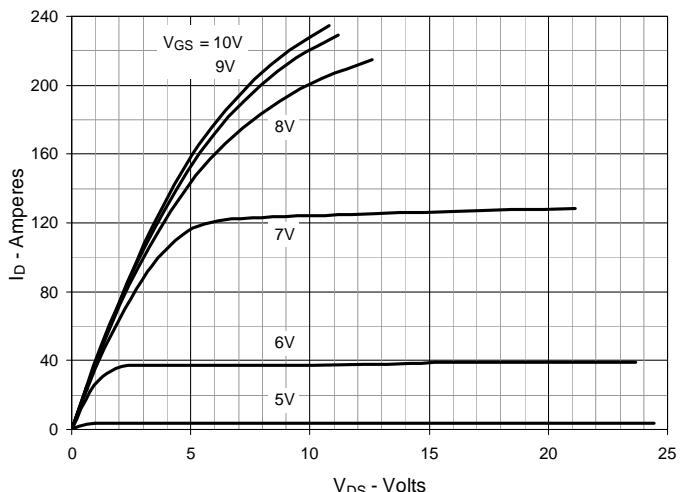
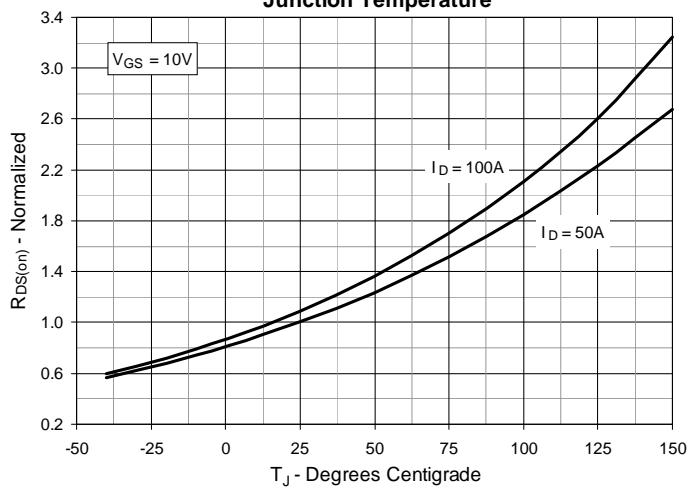
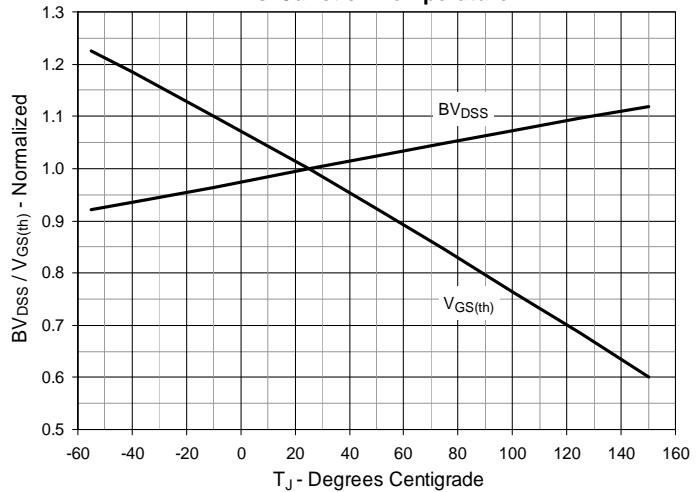
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$

Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 50\text{A}$ Value vs. Drain Current

Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 50\text{A}$ Value vs. Junction Temperature

Fig. 6. Normalized Breakdown & Threshold Voltages vs. Junction Temperature


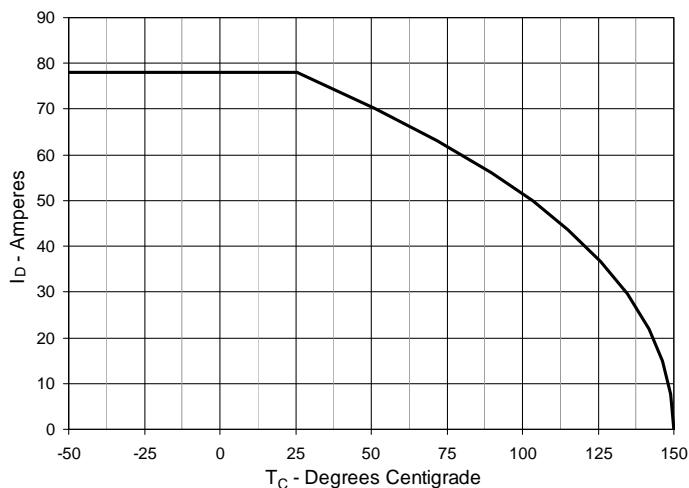
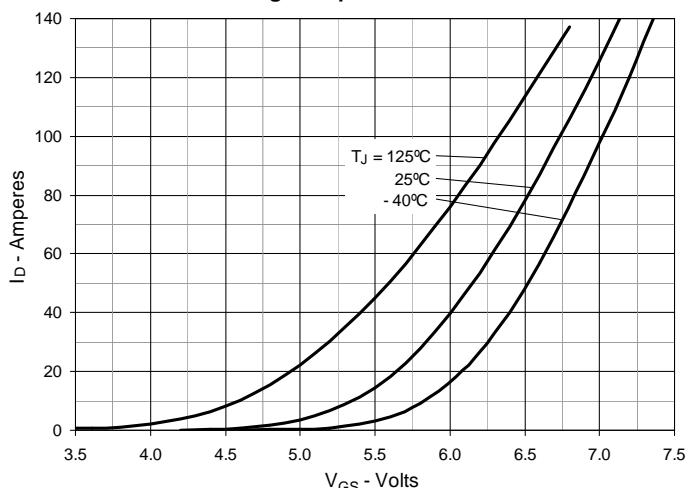
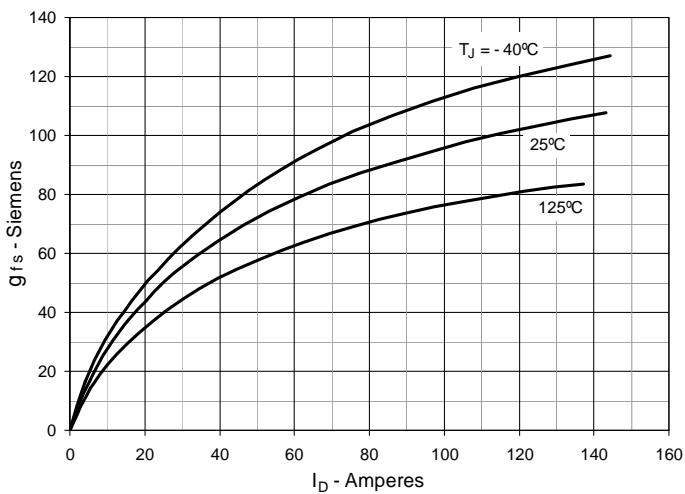
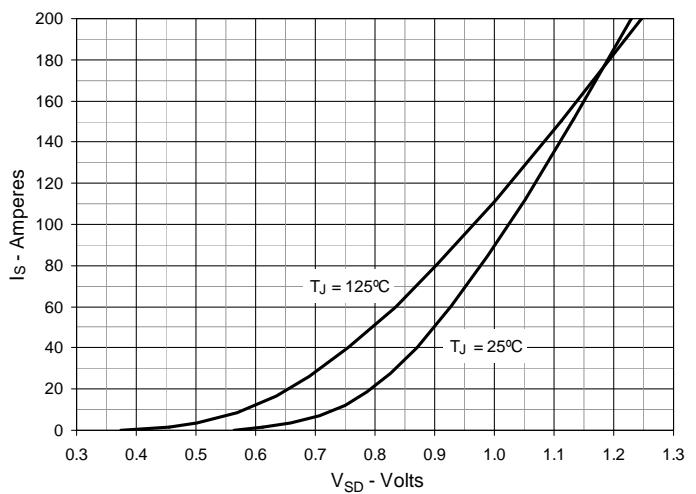
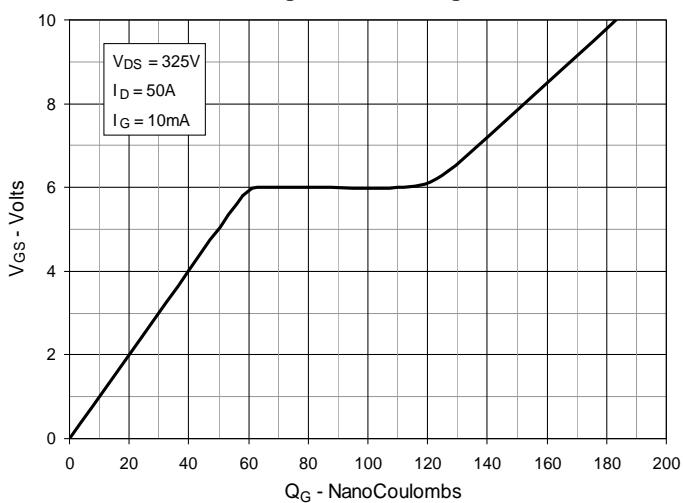
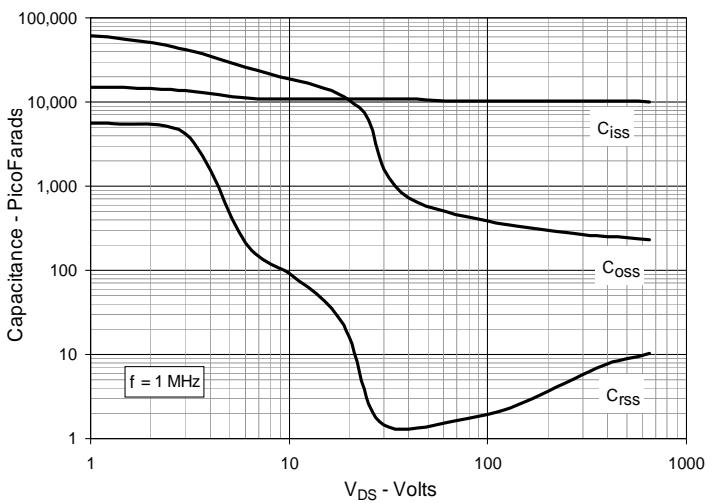
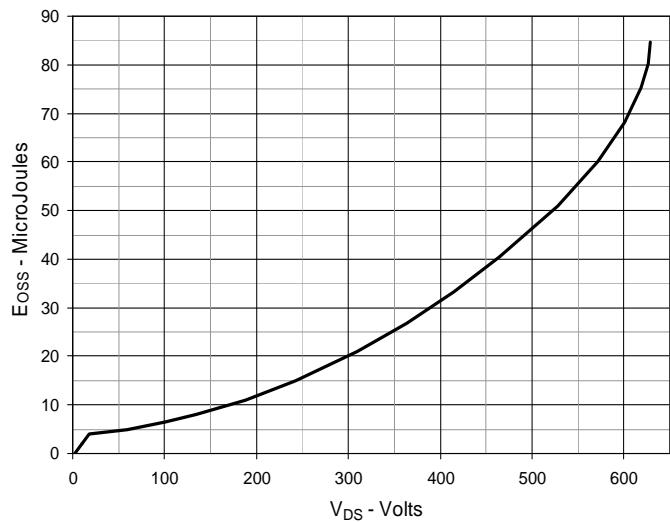
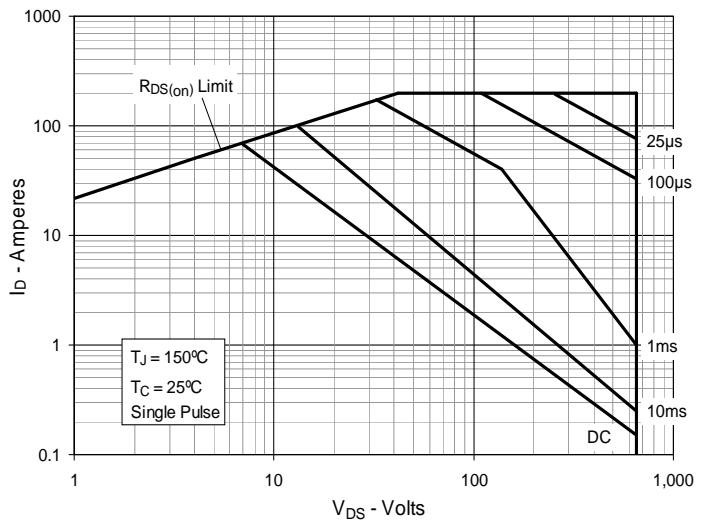
Fig. 7. Maximum Drain Current vs. Case Temperature**Fig. 8. Input Admittance****Fig. 9. Transconductance****Fig. 10. Forward Voltage Drop of Intrinsic Diode****Fig. 11. Gate Charge****Fig. 12. Capacitance**

Fig. 13. Output Capacitance Stored Energy**Fig. 14. Forward-Bias Safe Operating Area****Fig. 15. Maximum Transient Thermal Impedance**